MATERIALS AND FINISHES

BODY: BRASS
PLATED NICKEL

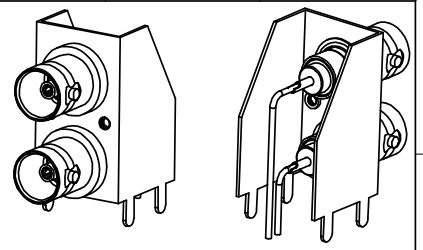
CENTER CONTACT: PHOSPHOR BRONZE
PLATED GOLD

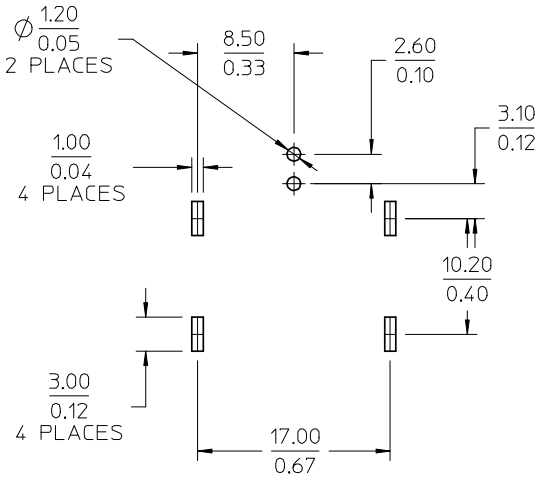
INSULATOR: TEFLON

PRESS RING: STEEL
PASSIVATE

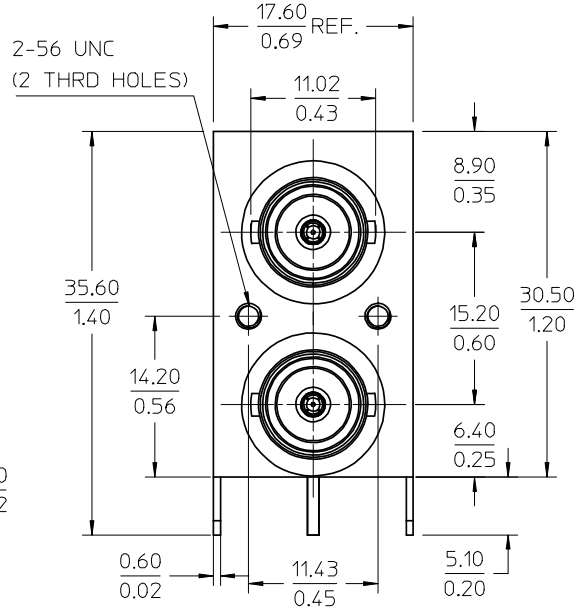
BRACKET: SPCC
PLATED NICKEL

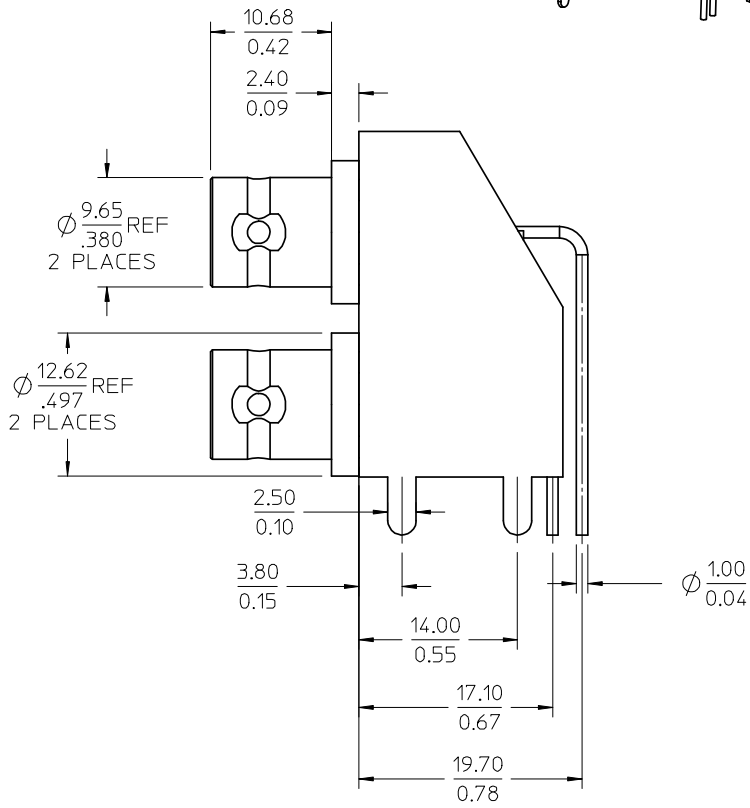
GROUNDING: COPPER OVER STEEL WIRE
PLATED TIN





RECOMMENDED PCB LAYOUT





73415-3981	1 PC PER BAG
73415-3980	TRAY
PART NO.	PACKAGING

PS-73598-0051	ELEC/MECH PERFORMANCE
MIL-STD-348A, FIG. 301.2	INTERFACE
SPECIFICATION	DESCRIPTION

CHG: UPDATED REVISED BNC BODY.
EC NO: URF2009-0015 2008/07/10
DRWN:AROBERTSON 2008/07/10
CH'KD:SSS
APPR: JWIENER 2008/07/10
DESCRIPTION
REV

A3

QUALITY SYMBOLS
▼=0
▽C=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± ---	± ---
1 PLACE	± ---	± ---
ANGULAR ± 2 °		

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: MM/IN
SCALE
DESIGN UNITS: METRIC
THIRD ANGLE PROJECTION

DRAWN BY: CLL I DATE: 2003/09/08
CHECKED BY: - DATE: 2003/09/08
APPROVED BY: - DATE: 2003/09/08

TITLE: BNC 75 OHMS JACK DUAL BNC-J/PCB

molex MOLEX INCORPORATED

MATERIAL NO.: SEE TABLE
DOCUMENT NO.: SD-73415-398
SHEET NO.: 1 OF 1

SIZE C

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